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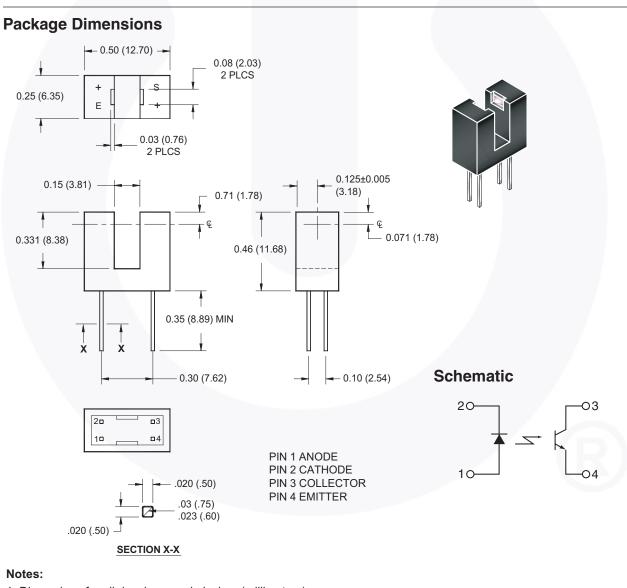
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QVE11233 Slotted Optical Switch

Features

- Lead spacing 0.300"
- Gap width of 0.150"
- Printed circuit board mounting
- 2mm aperture width



Description

across a 0.150" (3.81mm) gap.

The QVE11233 is designed to allow the user maximum flexibility in applications. Each switch consists of an

infrared emitting diode facing an NPN phototransistor

1. Dimensions for all drawings are in inches (millimeters).

2. Tolerance of ± 0.010 (0.25) on all non-nominal dimensions unless otherwise specified.

Absolute Maximum Ratings (TA = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating	Units	
T _{OPR}	Operating Temperature	-40 to +85	°C	
T _{STG}	Storage Temperature	-40 to +85	°C	
T _{SOL-I}	Soldering Temperature (Iron) ⁽²⁾⁽³⁾⁽⁴⁾	240 for 5 sec	°C	
T _{SOL-F}	Soldering Temperature (Flow) ⁽²⁾⁽⁴⁾	260 for 10 sec	°C	
INPUT (EMIT	TER)			
۱ _F	Continuous Forward Current	50	mA	
V _R	Reverse Voltage	6	V	
PD	Power Dissipation ⁽¹⁾	100	mW	
OUTPUT (SE	NSOR)			
V _{CEO}	Collector to Emitter Voltage	30	V	
V _{ECO}	Emitter to Collector Voltage	4.5	V	
۱ _C	Collector Current	20	mA	
PD	Power Dissipation ⁽¹⁾	150	mW	

Notes:

1. Derate power dissipation linearly, on each component, 1.67mW/°C above 25°C.

2. RMA flux is recommended.

3. Methanol or isopropyl alcohols are recommended as cleaning agents.

4. Soldering iron tip 1/16" (1.6mm) from housing.

Electrical/Optical Characteristics (T_A = 25°C)

Parameter	Test Conditions	Min.	Тур.	Max.	Units
TTER)					/
Forward Voltage	I _F = 20mA			1.7	V
Reverse Leakage Current	V _R = 2V			100	μA
ENSOR)		_			
Emitter to Collector Breakdown	I _E = 100μΑ, E _e = 0	5.0			V
Collector to Emitter Breakdown	$I_{\rm C} = 1 {\rm mA}, {\rm E}_{\rm e} = 0$	30			V
Collector to Emitter Leakage	$V_{CE} = 10V, E_{e} = 0$			100	nA
On-State Collector Current	$I_{F} = 20 \text{mA}, V_{CE} = 5 \text{V}$	0.5			mA
Saturation Voltage	I _F = 20mA, I _C = 0.25mA			0.40	V
	TTER) Forward Voltage Reverse Leakage Current ENSOR) Emitter to Collector Breakdown Collector to Emitter Breakdown Collector to Emitter Leakage On-State Collector Current	TTER)Forward Voltage $I_F = 20mA$ Reverse Leakage Current $V_R = 2V$ ENSOR)Emitter to Collector Breakdown $I_E = 100\mu A, E_e = 0$ Collector to Emitter Breakdown $I_C = 1mA, E_e = 0$ Collector to Emitter Leakage $V_{CE} = 10V, E_e = 0$ On-State Collector Current $I_F = 20mA, V_{CE} = 5V$	TTER)Forward Voltage $I_F = 20mA$ Reverse Leakage Current $V_R = 2V$ ENSOR)Emitter to Collector Breakdown $I_E = 100\muA, E_e = 0$ Collector to Emitter Breakdown $I_C = 1mA, E_e = 0$ 30Collector to Emitter Leakage $V_{CE} = 10V, E_e = 0$ 30On-State Collector CurrentIF = 20mA, VCE = 5V0.5	TTER) Forward Voltage $I_F = 20mA$ Reverse Leakage Current $V_R = 2V$ ENSOR) Emitter to Collector Breakdown Ic = 100µA, E _e = 0 5.0 Collector to Emitter Breakdown $I_C = 1mA, E_e = 0$ 30 Collector to Emitter Leakage $V_{CE} = 10V, E_e = 0$ 50 On-State Collector Current $I_F = 20mA, V_{CE} = 5V$ 0.5	TTER)Forward Voltage $I_F = 20mA$ 1.7Reverse Leakage Current $V_R = 2V$ 100ENSOR)Emitter to Collector Breakdown $I_E = 100\mu A, E_e = 0$ 5.0Collector to Emitter Breakdown $I_C = 1mA, E_e = 0$ 30Collector to Emitter Leakage $V_{CE} = 10V, E_e = 0$ 100

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